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SPECIFICATION

Device Name : IGBT Module

Type Name : 1MBI600PX - 120 - 01

Spec. No. : MS5F4405

Fuji Electric Co., Ltd.
Matsumoto Factory

	DATE	NAME	APPROVED		Fuji Electric Co., Ltd.	
DRAWN	Sep. 9, '98	S. Tashiro			DWG. NO.	MS5F4405 1/8
CHECKED	Sep. 9, '98	S. Miyatake				
			T. HOSOKAWA			

Revised Records

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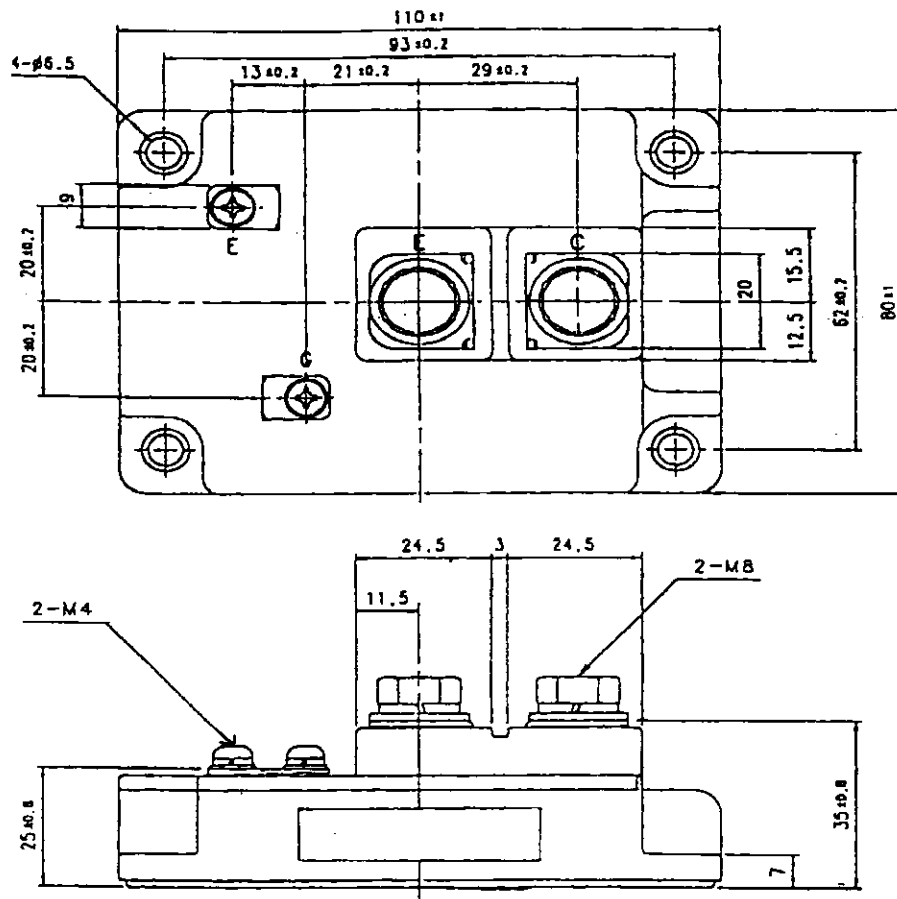
MS 5F4405

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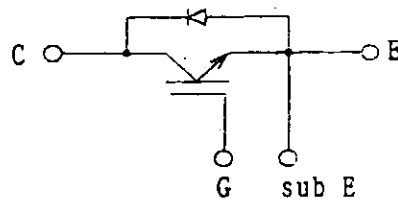
1MBI600PX-120-01

1. Outline Drawing

Unit : mm



2. Equivalent circuit



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3. Absolute Maximum Ratings (at $T_c=25^{\circ}\text{C}$ unless otherwise specified)

Items			Symbols	Ratings	Units
Collector-Emitter voltage			V_{CES}	1200	V
Gate-Emitter voltage			V_{GES}	± 20	V
Collector current	Continuous	$T_c=25^{\circ}\text{C}$	I_c	800	A
		$T_c=80^{\circ}\text{C}$		600	
	1ms	$T_c=25^{\circ}\text{C}$	I_c pulse	1600	
		$T_c=80^{\circ}\text{C}$		1200	
			$-I_c$	600	
	1ms		$-I_c$ pulse	1200	
Max. power dissipation			PC	4100	W
Operating temperature			T_j	+150	$^{\circ}\text{C}$
Storage temperature			T_{stg}	$-40\sim+125$	$^{\circ}\text{C}$
Isolation voltage			V_{is}	AC 2500 (1min.)	V
Screw torque			Mounting #1	4.5	N · m
			Terminals #2	11.0	
			Terminals #3	1.7	

Note : #1 Recommendable value : $4.0 \pm 0.5 \text{ N} \cdot \text{m}$ (M6)

Note : #2 Recommendable value : $10.0 \pm 1.0 \text{ N} \cdot \text{m}$ (M8)

Note : #3 Recommendable value : $1.50 \pm 0.2 \text{ N} \cdot \text{m}$ (M4)

4. Electrical characteristics (at $T_j=25^{\circ}\text{C}$ unless otherwise specified)

Items	Symbols	Characteristics			Conditions	Units
		min.	typ.	max.		
Zero gate voltage Collector current	I_{CES}			2.0	$V_{GE}=0\text{V}, V_{CE}=1200\text{V}$	mA
Gate-Emitter leakage current	I_{GES}			± 0.5	$V_{CE}=0\text{V}, V_{GE}=\pm 20\text{V}$	μA
Gate-Emitter threshold voltage	$V_{GE(th)}$	6.0	8.0	9.0	$V_{CE}=20\text{V}, I_c=600\text{mA}$	V
Collector-Emitter saturation voltage	$V_{CE(sat)}$	2.5	2.85	3.0	$V_{GE}=15\text{V}, I_c=600\text{A}$	V
Input capacitance	C_{ies}		60		$V_{GE}=0\text{V}$	nF
Output capacitance	C_{oes}		9		$V_{CE}=10\text{V}$	
Reverse transfer capacitance	C_{res}		4		$f=1\text{MHz}$	
Turn-on time	t_{on}		750	1200	$V_{cc}=600\text{V}$	ns
	t_r		200	600	$I_c=600\text{A}$	
Turn-off time	t_{off}		650	1000	$V_{GE}=\pm 15\text{V}$	
	t_f		100	300	$R_g=2.0\Omega$	
Diode forward on voltage	V_F	2.0		3.4	$I_F=600\text{A}, V_{CE}=0\text{V}$	V
Reverse recovery time	t_{rr}			350	$I_F=600\text{A}$	ns

5. Thermal resistance characteristics

Items	Symbols	Characteristics			Conditions	Units
		min.	typ.	max.		
Thermal resistance	$R_{th(j-c)}$			0.03	IGBT	$^{\circ}\text{C/W}$
	$R_{th(j-c)}$			0.06	Diode	
	※		0.0063		the base to cooling fin	
	$R_{th(c-f)}$					

※ This is the value which is defined mounting on the additional cooling fin with thermal compound.

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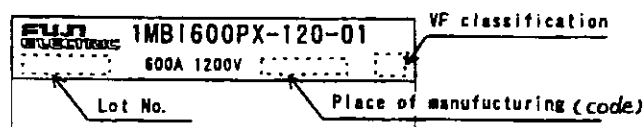
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6. VF class

class	VF range [V]
A	2.0 ~ 2.3
B	2.2 ~ 2.5
C	2.4 ~ 2.7
D	2.6 ~ 3.0
E	2.9 ~ 3.4

7. Indication module (モジュール表示)



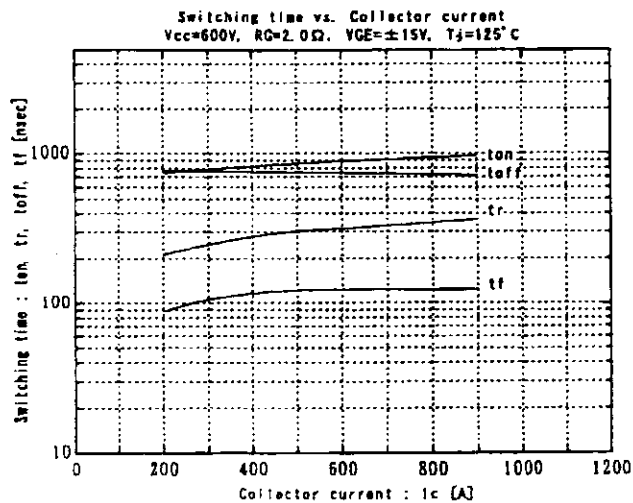
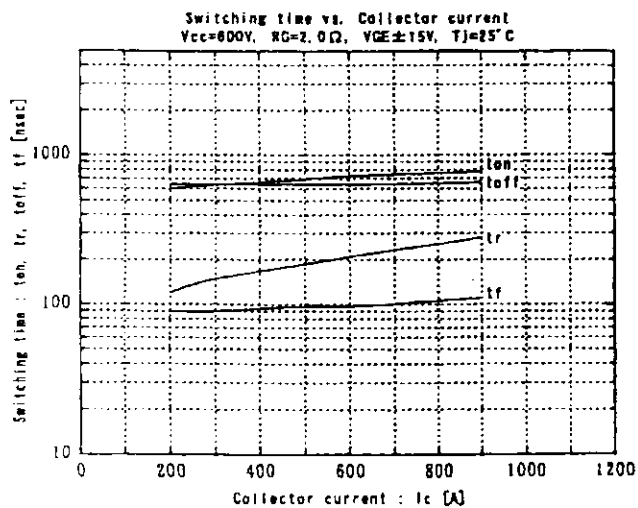
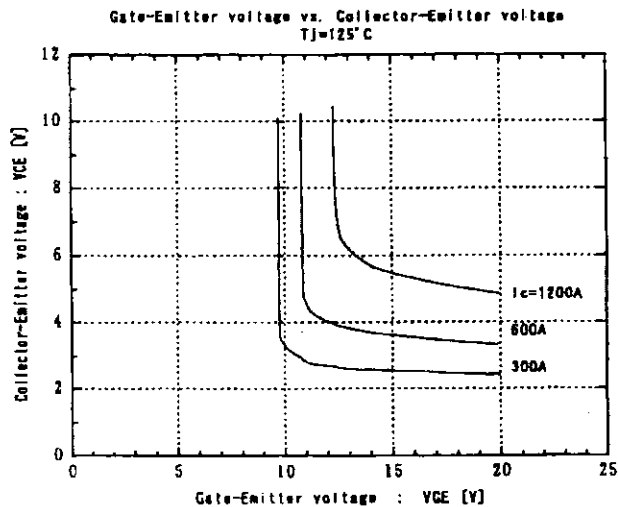
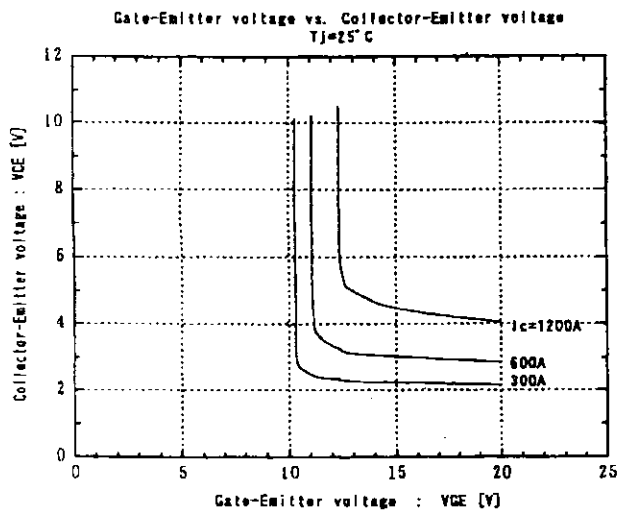
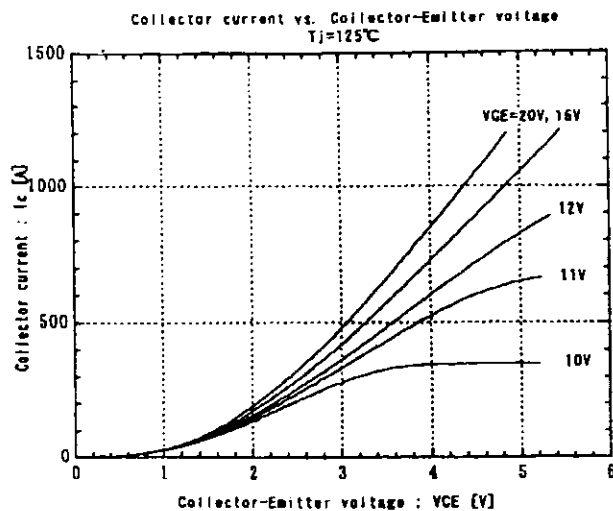
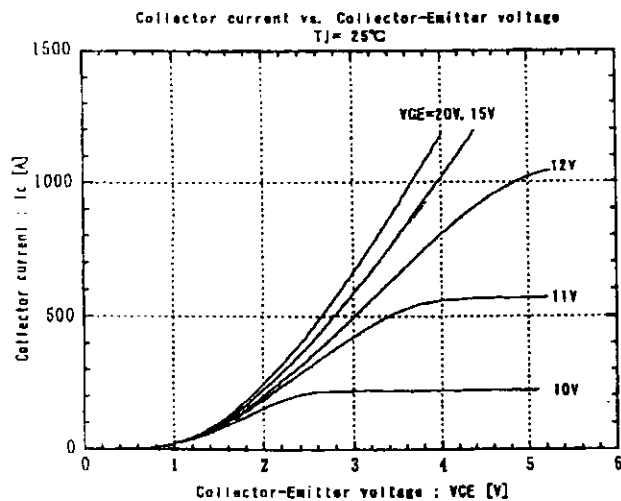
8. Applicable category (適用範囲)

This specification is applied to IGBT module named 1MBI600PX-120-01.
 本納入仕様書は、IGBTモジュール1MBI600PX-120-01に適用する。

9. Storage and transportation notes (保管、運搬上の注意事項)

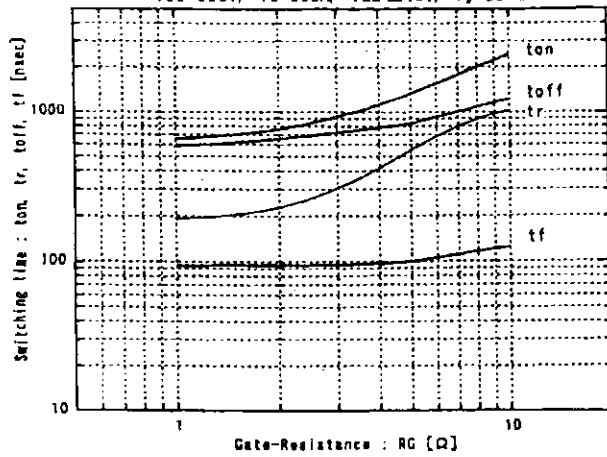
- This IGBT module should be stored at a standard temperature of 5 to 35℃ and humidity of 45% to 75%.
 常温保管が望ましい。
- Store modules in a place with few temperature changes in order to avoid condensation on the module surface.
 急激な温度変化の無きこと。(モジュール表面が結露しないこと)
- Avoid exposure to corrosive gases and dust.
 腐蝕性ガスの発生場所、塵埃の多い場所は避けること。
- Avoid excessive external force on the module.
 製品に荷重がかからないように十分注意すること。
- Store modules with unprocessed terminals.
 モジュールの端子は未加工の状態で保管すること。
- Do not drop or otherwise shock the modules when transporting.
 製品の運搬時に衝撃を与えたり、落下させたりしないこと。

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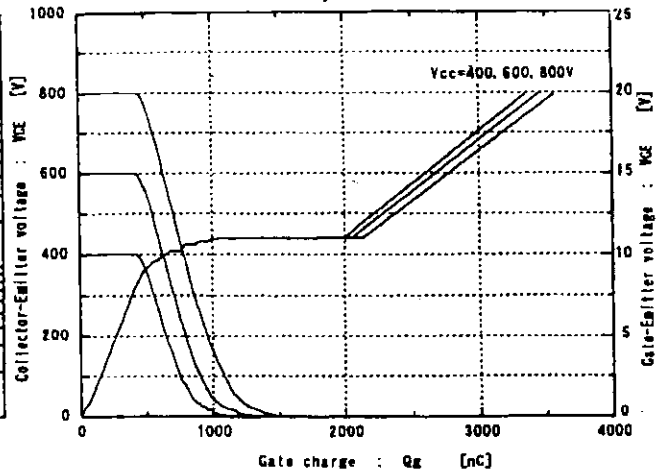


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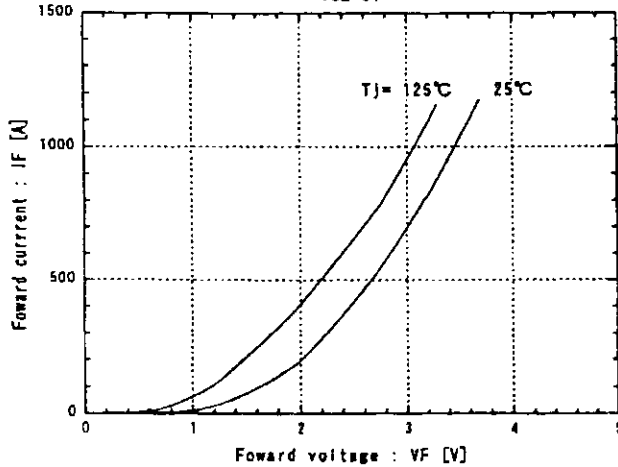
Switching time vs. Gate-Resistance
 $V_{CC}=600V$, $I_C=600A$, $V_{GE} \pm 15V$, $T_J=25^\circ C$



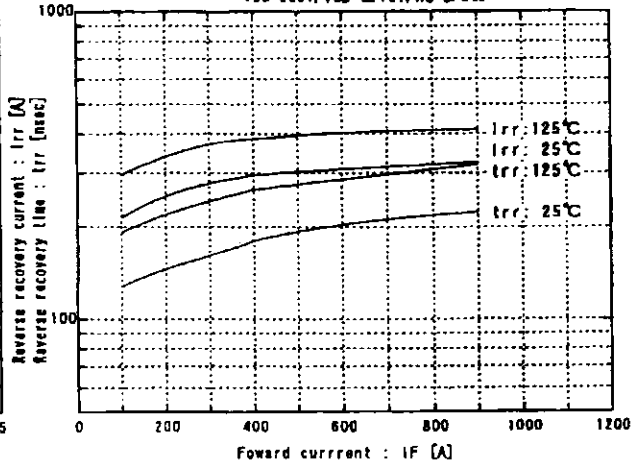
Dynamic input characteristics
 $T_J=25^\circ C$



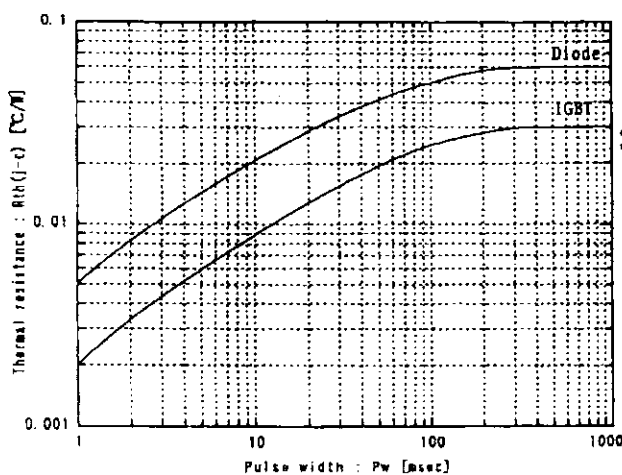
Forward current vs. Forward voltage
 $V_{GE}=0V$



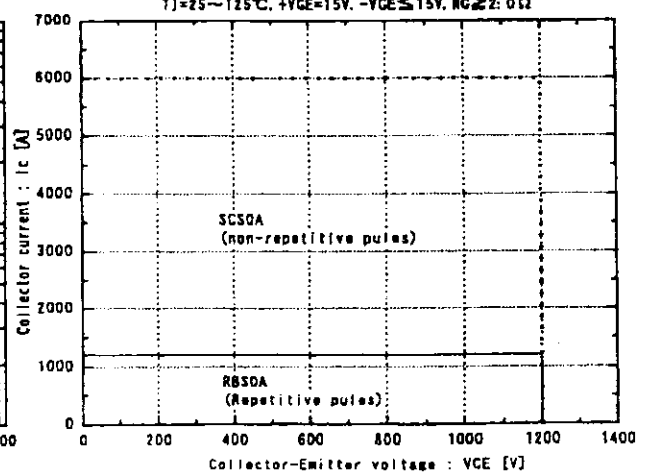
Reverse recovery characteristics (t_{rr} , I_{rr} vs. I_F)
 $V_{CC}=600V$, $V_{GE}=\pm 15V$, $R_G=2.0\Omega$



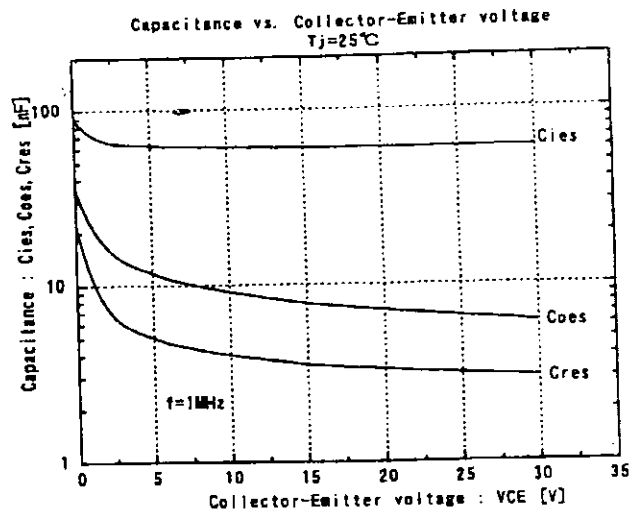
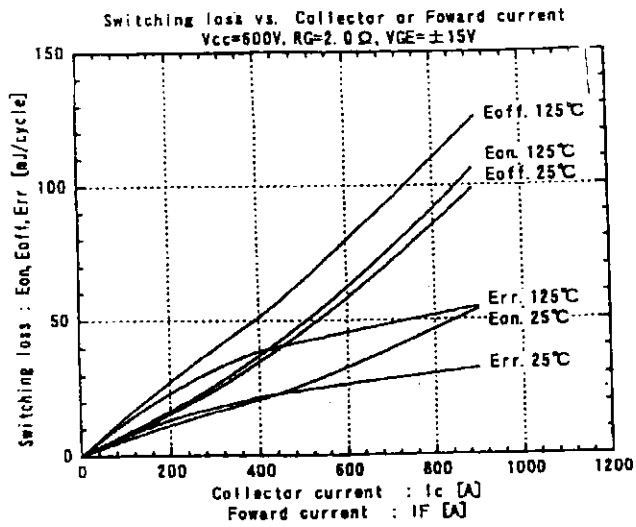
Transient thermal resistance



Reverse biased safety operating area
 $T_J=25\sim 125^\circ C$, $+V_{GE}=15V$, $-V_{GE}\leq 15V$, $R_G\geq 2.0\Omega$



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